

Primax

Synonymous with function and performance, enter the Primax, the new era of high intensity illumination in LED. With its high flux output and high luminous intensity, Primax transcends today LED lightings technology and how we perceive it. The small package outline and high intensity make it an ideal choice for backlighting, signage, exterior automotive lighting and decorative lighting.



Features:

- > Super high brightness surface mount LED
- > 120° viewing angle.
- > Compact package outline (LxW) of 3.7 x 3.5 mm.
- > Ultra low height profile - 0.8mm.
- > Low thermal resistance.
- > Compatible to IR reflow soldering.
- > Superior corrosion resistant.
- > Environmental friendly; RoHS compliance.
- > Compliance to automotive standard; AEC-Q102.



Applications:

- > Automotive: exterior applications, eg: signal lighting, Center High Mounted Stop Light (CHMSL), Rear Combination Lamp (RCL), Rear Fog Lamp.

Optical Characteristics at T_j=25°C

Part Number	Color	Viewing Angle°	Luminous Flux @ 350mA (lm) <i>Appx. 1.2</i>		
			Min.	Typ.	Max.
● MAA-UZHG-SU2-1	Amber, 615nm	120	51.7	76.5	99.4
● MAA-UZHG-S3T-2	Amber, 615nm	120	59.0	76.5	87.4
● MAA-UZHG-ST2-4	Amber, 624nm	120	51.7	67.2	76.5
● MAA-UZHG-S9T-2	Amber, 615nm	120	63.0	82.0	93.4
● MAA-UZHG-ST8-4	Amber, 624nm	120	55.4	72.0	82.0

● Not for new design.

Electrical Characteristics at T_j=25°C

Part Number	V _f @ I _f = 350 mA <i>Appx. 3.1</i>		
	Min. (V)	Typ. (V)	Max. (V)
M _A x-UZHG	1.90	2.30	2.65

Absolute Maximum Ratings

	Maximum Value	Unit
DC forward current	400	mA
Peak pulse current (T _s =55 °C, t _p ≤ 100µs, Duty cycle = 0.03)	750	mA
Reverse Voltage	Not designed for reverse bias	V
ESD threshold (HBM)	8	kV
LED junction temperature	150	°C
Operating temperature	-40 ... +125	°C
Storage temperature	-40 ... +125	°C
Thermal resistance (Rated current = 350mA, T _s = 25 °C)		
- Real Thermal Resistance		
Junction / solder point, R _{th JS real} (Typ = 16K/W)	23	K/W
- Electrical Thermal Resistance		
Junction / solder point, R _{th JS el} (Typ = 12K/W)	17	K/W

Wavelength Grouping at Tj=25°C

Color	Group	Wavelength distribution (nm) <i>Appx. 2.2</i>
MAA; Amber	Full	612 - 624
	W	612 - 616
	X	616 - 620
	Y	620 - 624
	Z	624 - 627

Luminous Flux at Tj=25°C

Brightness Group	Luminous Flux @ If=350mA (lm) <i>Appx. 1.2</i>
S2	51.7 ... 59.0
S3	59.0 ... 67.2
T2	67.2 ... 76.5
T3	76.5 ... 87.4
U2	87.4 ... 99.4
S8	55.4 ... 63.0
S9	63.0 ... 72.0
T8	72.0 ... 82.0
T9	82.0 ... 93.4

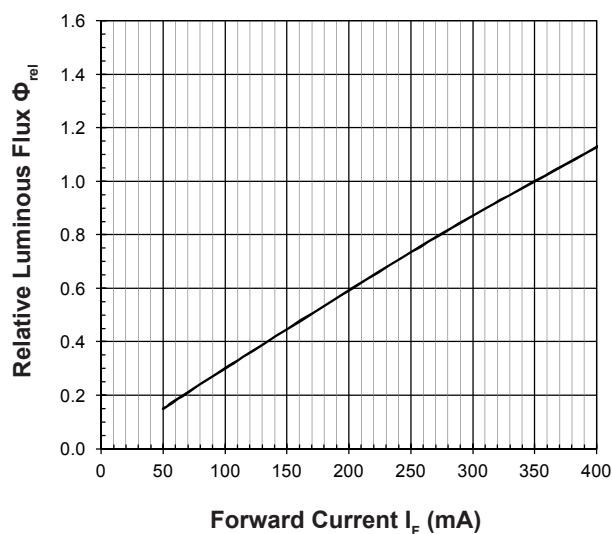
Vf Binning (Optional)

Vf Bin @ 350mA	Forward Voltage (V) <i>Appx. 3.1</i>
V1	1.90 ... 2.05
V2	2.05 ... 2.20
V3	2.20 ... 2.35
V4	2.35 ... 2.50
V5	2.50 ... 2.65

Please consult sales and marketing for special part number to incorporate Vf binning.

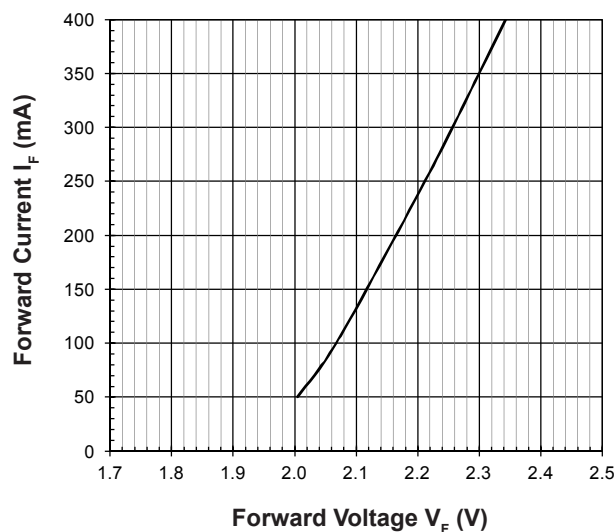
Relative Luminous Flux Vs Forward Current

$$\Phi_V / \Phi_V(350\text{mA}) = f(I_F); T_j = 25^\circ\text{C}$$



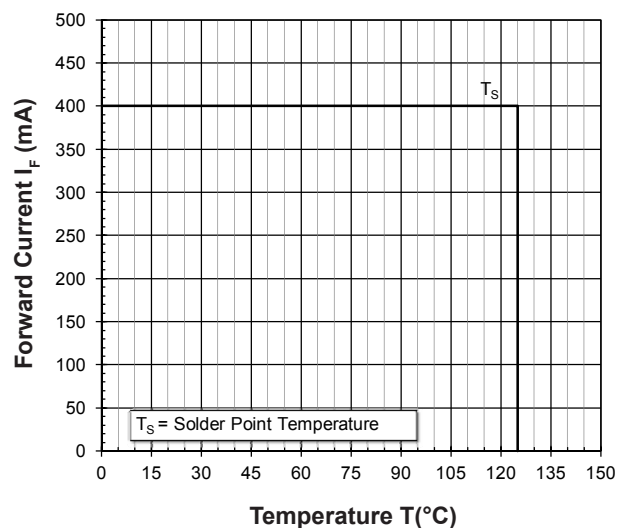
Forward Current Vs Forward Voltage

$$I_F = f(V_F); T_j = 25^\circ\text{C}$$



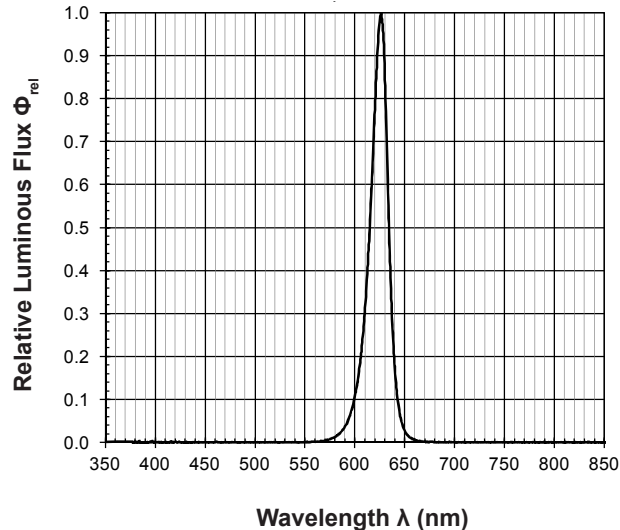
Maximum Current Vs Temperature

$$I_F = f(T)$$



Relative Spectral Emission

$$\Phi_{rel} = f(\lambda); T_j = 25^\circ\text{C}; I_F = 350\text{mA}$$

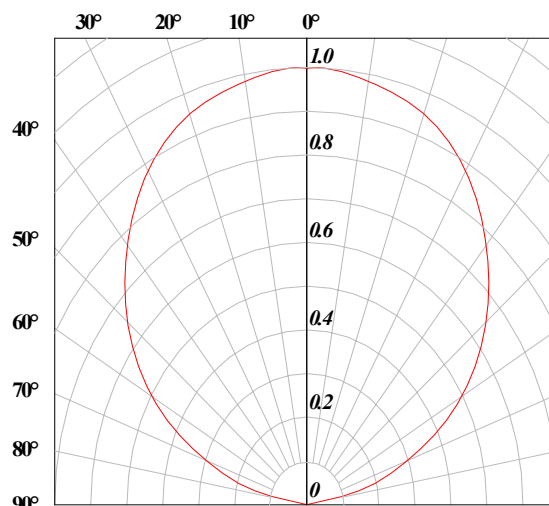


Allowable Forward Current Vs Duty Ratio

$$(T_s = 55^\circ\text{C}; t_p \leq 100\mu\text{s})$$

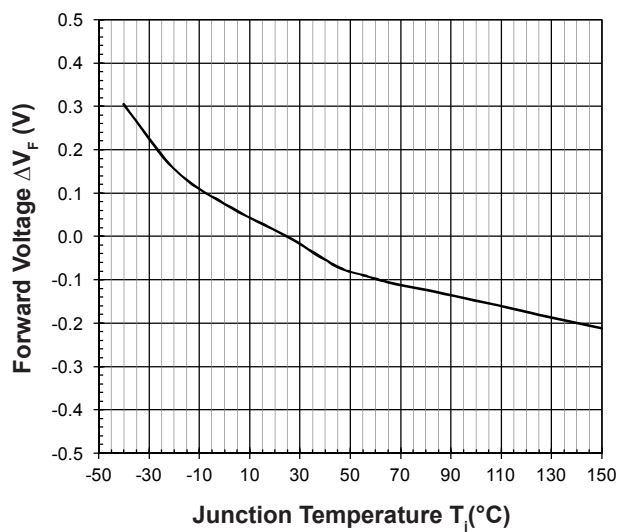


Radiation Pattern



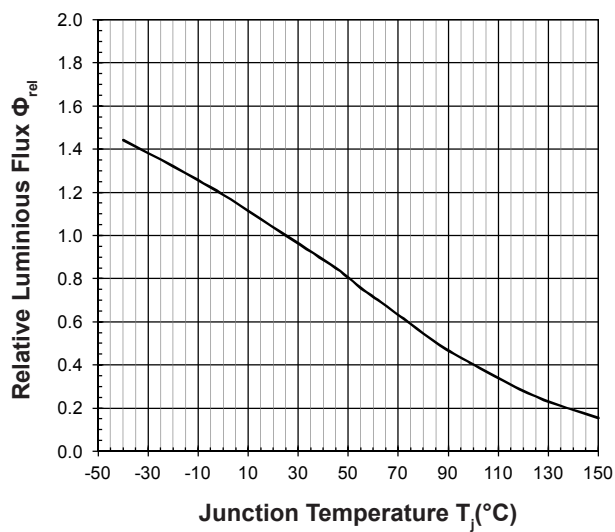
Forward Voltage Vs Junction Temperature

$$\Delta V_F = V_F - V_F(25^\circ\text{C}) = f(T_j); I_F = 350\text{mA}$$



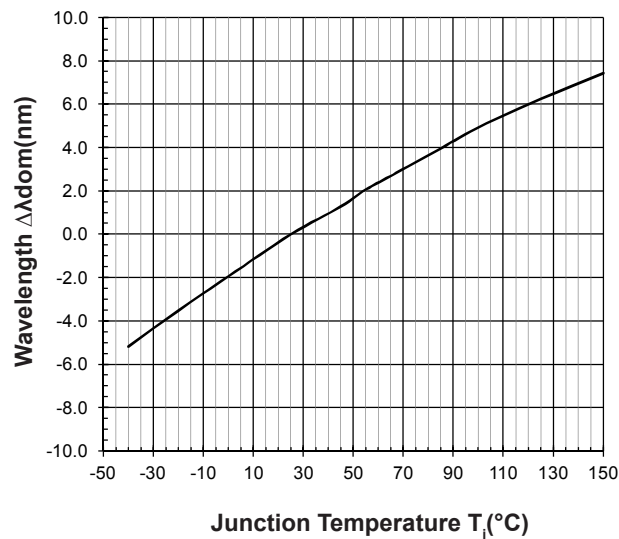
Relative Luminous Flux Vs Junction Temperature

$$\Phi_V / \Phi_V(25^\circ\text{C}) = f(T_j); I_F = 350\text{mA}$$

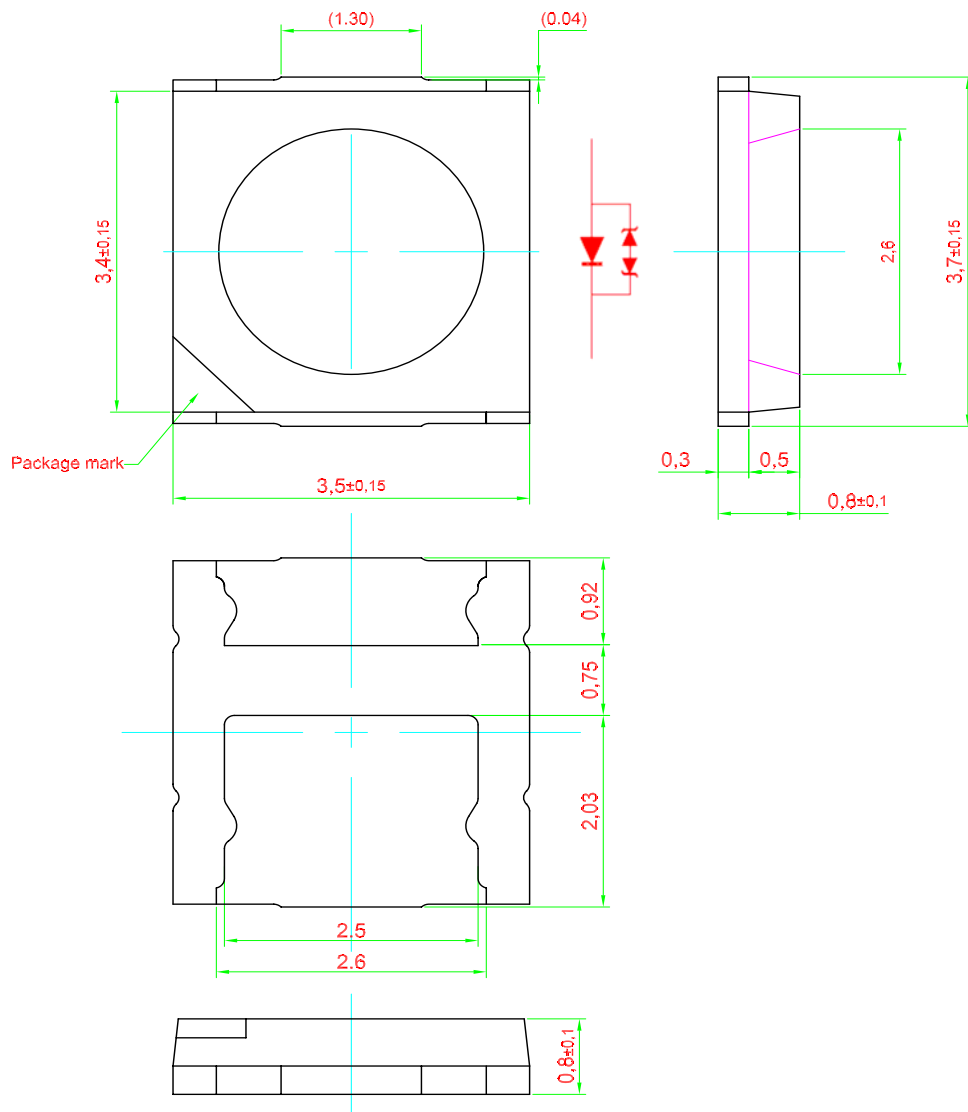


Wavelength Vs Junction Temperature

$$\Delta \lambda_{dom} = \lambda_{dom} - \lambda_{dom}(25^\circ\text{C}) = f(T_j); I_F = 350\text{mA}$$



PrimaxPlus • AllnGaP: MAx-UZHG Package Outlines

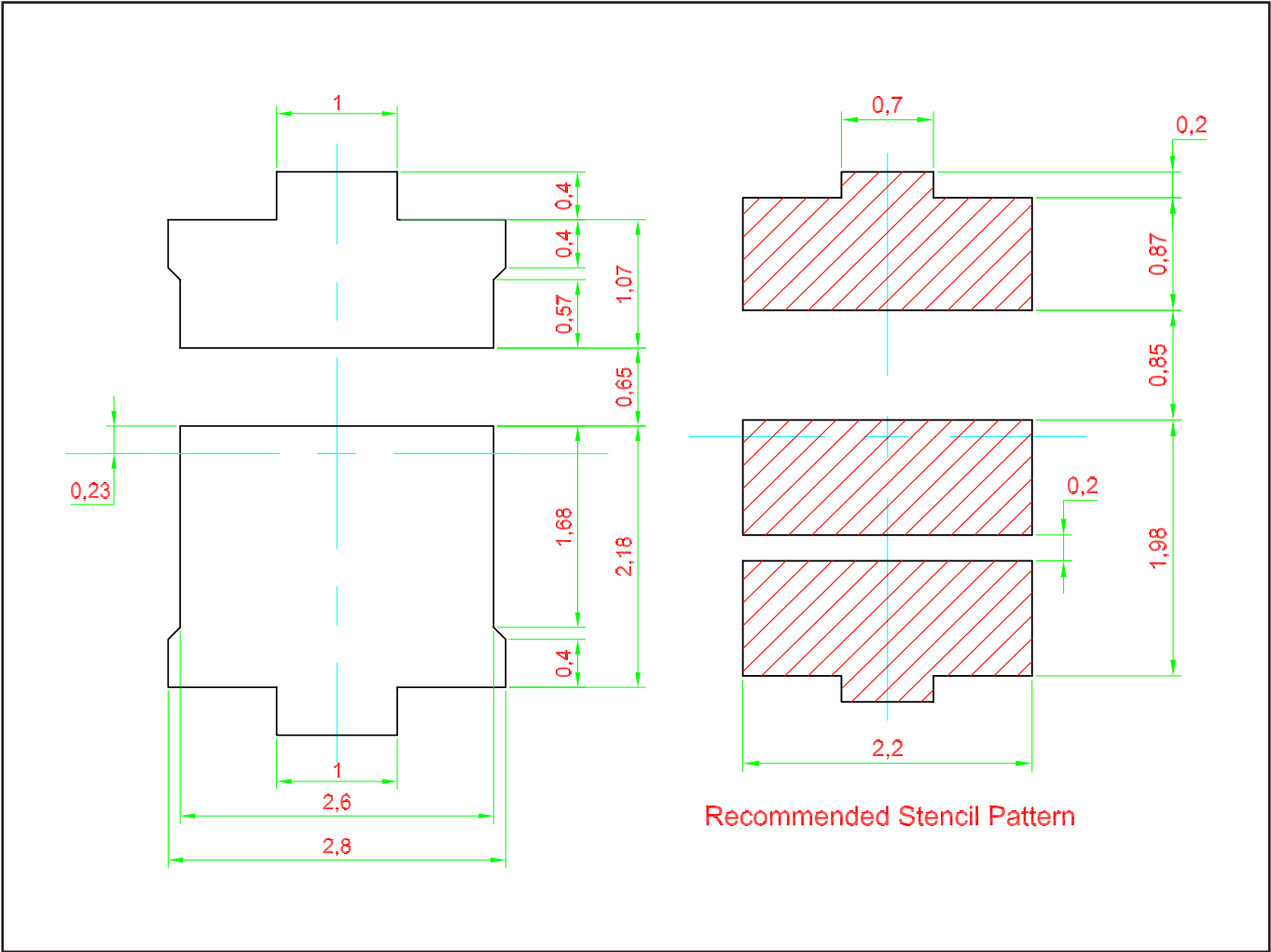


Notes:
 Primary thermal path is through Cathode lead of LED package.
 General tolerance: ± 0.1 mm.

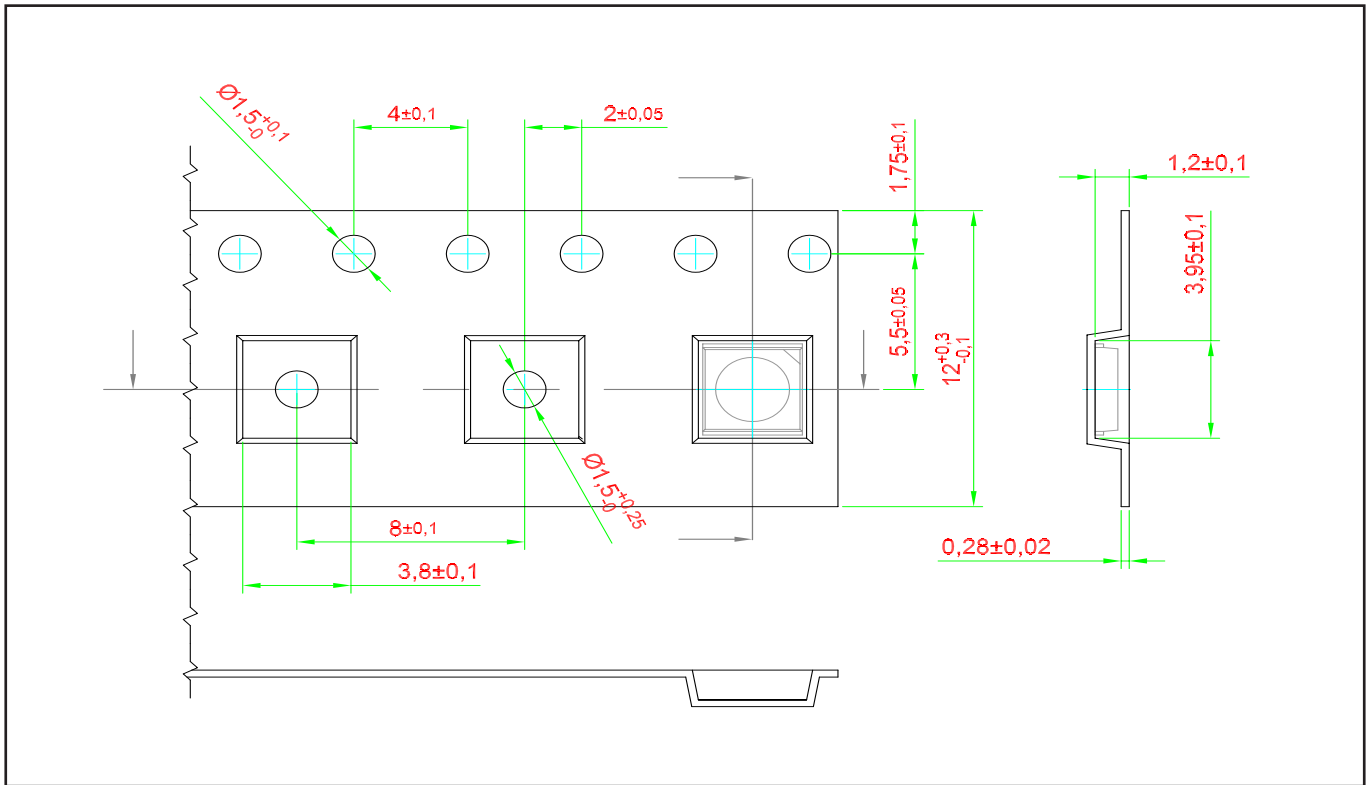
Material

Material	
Lead-frame	Cu Alloy With Au Plating
Package	High Temperature Resistant Plastic
Encapsulant	Silicone Resin
Soldering Leads	Au Plating

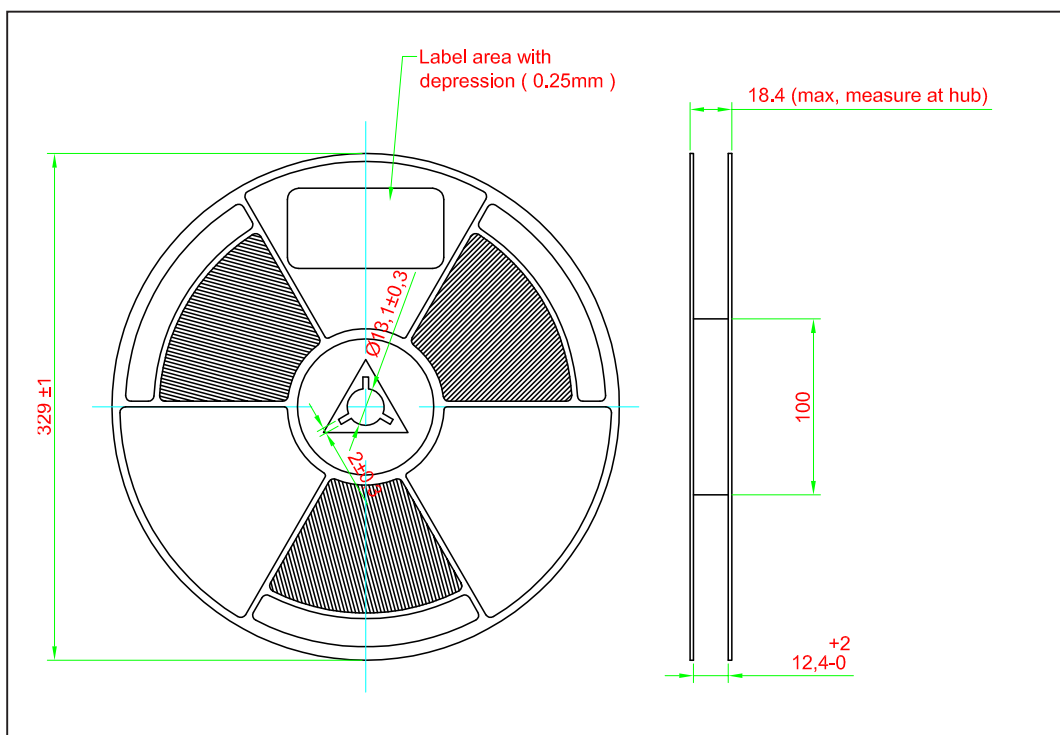
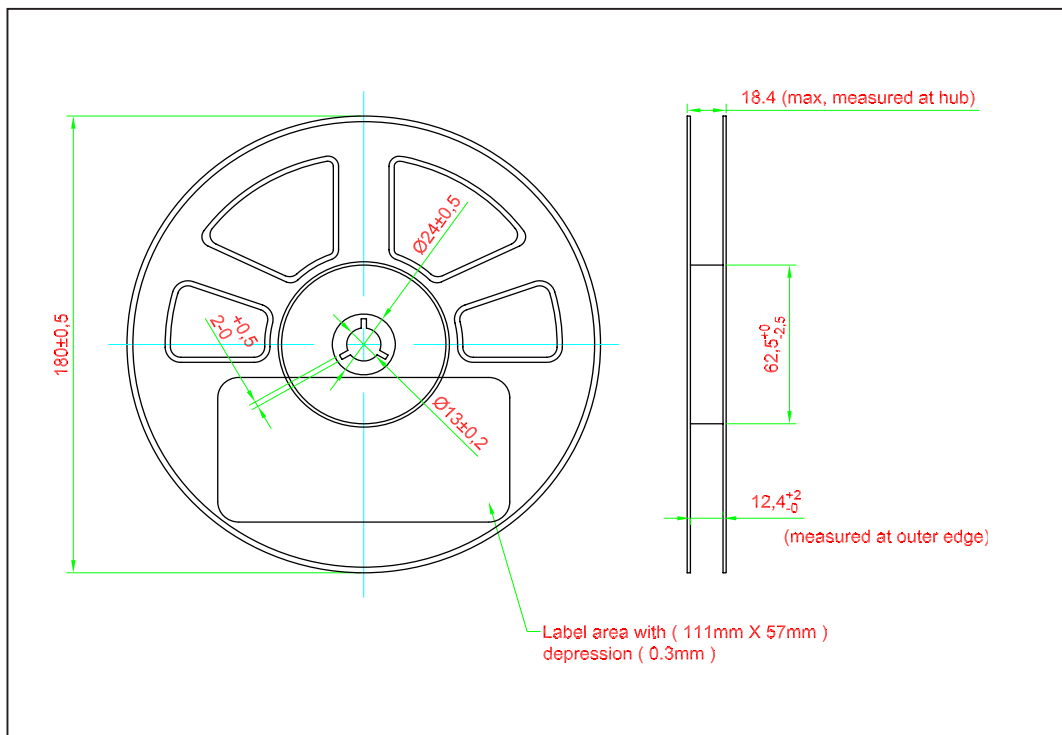
Recommended Solder Pad



Taping and orientation



Packaging Specification

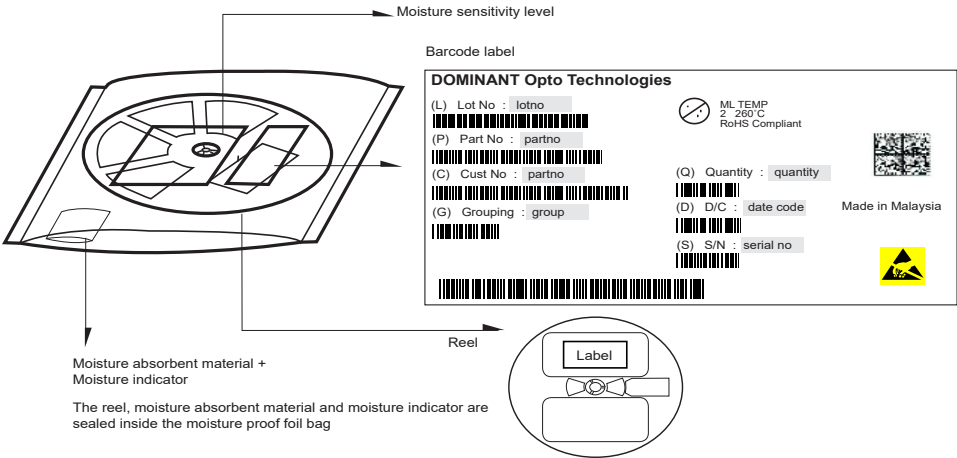


	Reel Diameter (mm)	Quantity (pcs)	*Ordering Number
Standard Packing	180	1500	MAx-UZHG-xxx-x
Optional Packing	329	5000	MAx-UZHG-xxx-x-5

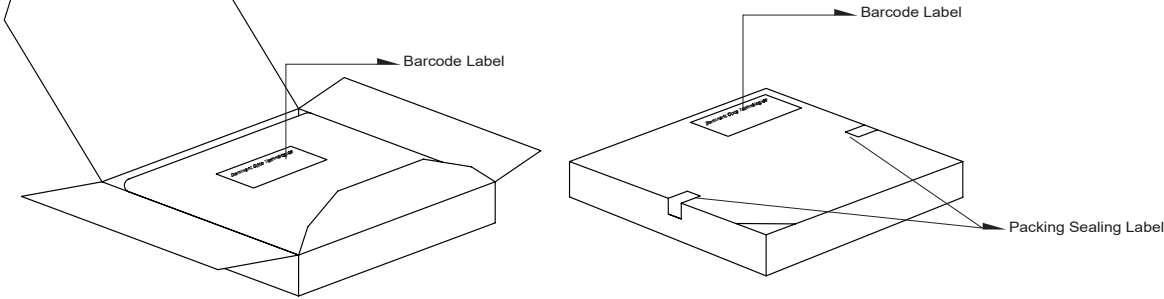
Notes:

* For ordering purpose only. Please consult sales and marketing for details.

Packaging Specification



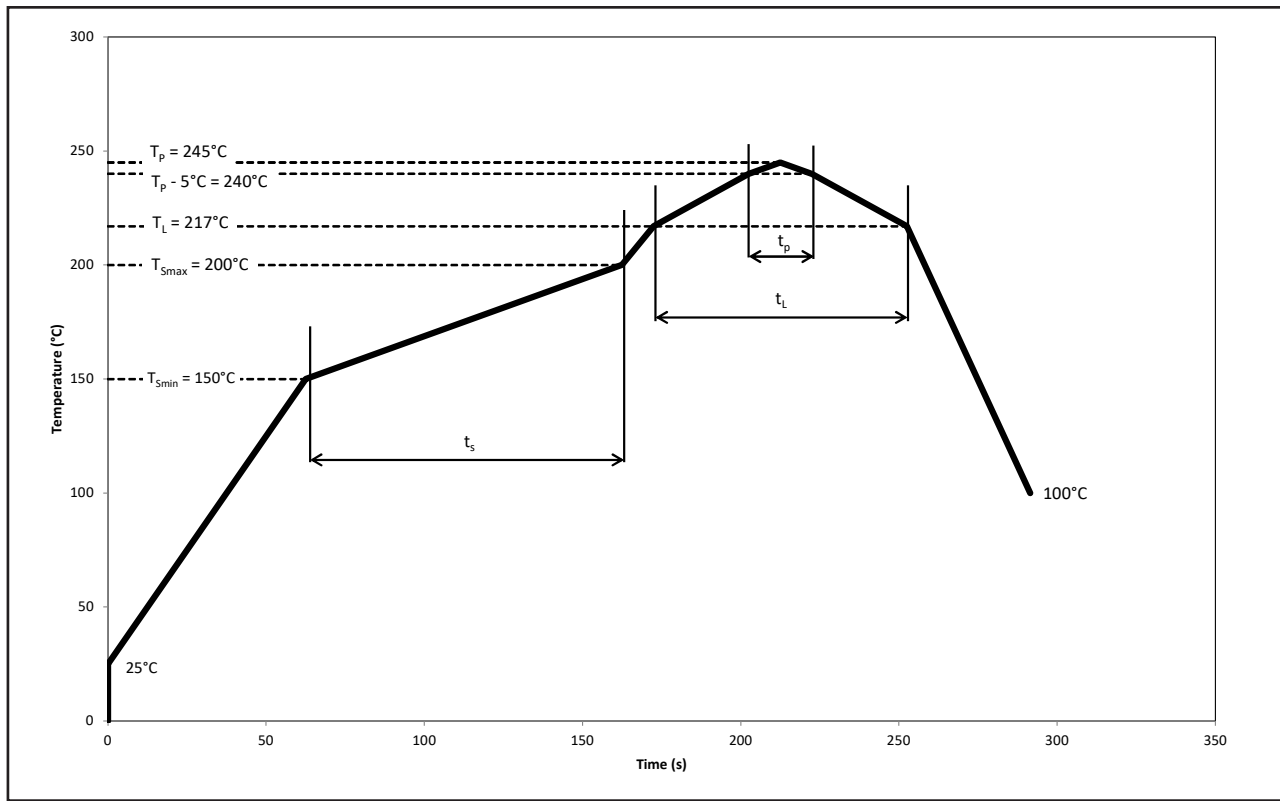
Quantity per bag (pcs)	Average 1pc PrimaxPlus (g)	1 completed bag (g)
1500	0.034	245 ± 10
5000	0.034	1150 ± 10



Reel Diameter (mm)	Packing Box Dimensions (mm)
180	210 x 210 x 20
329	345 x 345 x 20

Recommended Pb-free Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E



Profile Feature	Symbol	Min.	Pb-Free Assembly		Unit
			Recommended	Max.	
Ramp-up rate to preheat 25°C to T_{smin}	-	-	2	3	$^{\circ}\text{C/s}$
Time t_s T_{smin} to T_{smax}	t_s	60	100	120	s
Ramp-up rate to peak T_L to T_p	-	-	2	3	$^{\circ}\text{C/s}$
Liquidous temperature	T_L	-	217	-	$^{\circ}\text{C}$
Time above liquidous temperature	t_L	60	80	150	s
Peak temperature	T_p	-	245	260	$^{\circ}\text{C}$
Time within 5°C of the specified peak temperature $T_p - 5^{\circ}\text{C}$	t_p	10	20	30	s
Ramp-down rate T_p to 100°C	-	-	3	6	$^{\circ}\text{C/s}$
Time 25°C to T_p	-	-	-	480	s

Appendix

1) **Brightness:**

- 1.1 Luminous intensity is measured at current pulse 25 ms(typ) with an internal reproducibility of $\pm 8 \%$ and an expanded uncertainty of $\pm 11 \%$ (according to GUM with a coverage factor of $k=3$).
- 1.2 Luminous flux is measured at current pulse 25 ms(typ) with an internal reproducibility of $\pm 8 \%$ and an expanded uncertainty of $\pm 11 \%$ (according to GUM with a coverage factor of $k=3$).
- 1.3 Radiant intensity is measured at current pulse 25 ms(typ) with an internal reproducibility of $\pm 8 \%$ and an expanded uncertainty of $\pm 11 \%$ (according to GUM with a coverage factor of $k=3$).
- 1.4 Radiant flux is measured at current pulse 25 ms(typ) with an internal reproducibility of $\pm 8 \%$ and an expanded uncertainty of $\pm 11 \%$ (according to GUM with a coverage factor of $k=3$).

2) **Color:**

- 2.1 Chromaticity coordinate groups are measured at current pulse 25 ms(typ) with an internal reproducibility of ± 0.005 and an expanded uncertainty of ± 0.01 (accordingly to GUM with a coverage factor of $k=3$).
- 2.2 Dominant wavelength is measured at current pulse 25 ms(typ) with an internal reproducibility of $\pm 0.5\text{nm}$ and an expanded uncertainty of $\pm 1\text{nm}$ (accordingly to GUM with a coverage factor of $k=3$).

3) **Voltage:**

- 3.1 Forward Voltage, V_f is measured when a current pulse of 8 ms(typ) with an internal reproducibility of $\pm 0.05\text{V}$ and an expanded uncertainty of $\pm 0.1\text{V}$ (accordingly to GUM with a coverage factor of $k=3$).

4) **Typical Values:**

- 4.1 At special conditions of LED manufacturing processes, typical data or calculated correlations of technical parameters only reflect the statistical figures. But not necessarily correspond to the actual parameters of each single product, which could differ from the typical data or calculated correlations or the typical characteristic line. These typical data may change whenever technical improvements happen.

5) **Tolerance of Measure**

- 5.1 Unless otherwise noted in drawing, tolerances are specified with ± 0.1 and dimension are specific in mm.

Revision History

Page	Subjects	Date of Modification
-	Initial Release	24 Mar 2017
6	Update Package Outline	17 May 2017
2, 10, 12	Not for New Design: MAA-UZHG-SU2-1 Add New Partno: MAA-UZHG-S3T-2 & MAA-UZHG-ST2-4 Update Packaging Specification Update Appendix	07 Jun 2018
2	Add New Partno: MAA-UZHG-S9T-2 & MAA-UZHG-ST8-4	19 Dec 2018
2, 11	Not for New Design: MAA-UZHG-S3T-2, MAA-UZHG-ST2-4, MAA-UZHG-S9T-2 & MAA-UZHG-ST8-4 Update Recommended Pb-free Soldering Profile	25 Feb 2021
1, 2, 4	Update Features (AEC-Q101 to AEC-Q102) Update Test Condition for Peak Pulse Current Update Allowable Forward Current Vs Duty Ratio Graph	16 Mar 2021
9, 10	Update Packaging Specification	03 Mar 2022
9, 10	Update Quantity per Reel: 1000pcs to 1500pcs	01 Nov 2023

NOTE

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About Us

DOMINANT Opto Technologies is a dynamic company that is amongst the world's leading automotive LED manufacturers. With an extensive industry experience and relentless pursuit of innovation, DOMINANT's state-of-art manufacturing and development capabilities have become a trusted and reliable brand across the globe. More information about DOMINANT Opto Technologies, an IATF 16949 and ISO 14001 certified company, can be found under <http://www.dominant-semi.com>.

Please contact us for more information:

DOMINANT Opto Technologies Sdn. Bhd.
Lot 6, Batu Berendam, FTZ Phase III, 75350 Melaka, Malaysia
Tel: (606) 283 3566 Fax: (606) 283 0566
E-mail: sales@dominant-semi.com